ASSOCIATION CONNECTION ELECTRONICS INDUSTRI	Material Comp © Copyright 2005. international and Pa	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.											
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater						rials and M	ials and Mfg Information				
Supplier Inform	nation																
Company name* Company unique ID				ique ID	Unic			Unique ID Authority					Response Date*				
onsemi													2025-08-30				
Contact Name		Title - Conta	Title - Contact			Phone - Contact*					Email -	Email - Contact*					
Product-Env-Stew	ards	Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com						
Authorized Repres	Title - Repre	Title - Representative			Phone - Representative*					Email - Representative*							
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
Request	ster Item Number Mfr Item Nu NCV7708FI		m Number Mfr Item Name				Effective Date Version Manu		Manufact	unufacturing Site		Veight*	*	UOM	Unit Type		
			08FDWR2G	FDWR2G Automotive Driver			2025-08-30	08-30 PH1		7	792.01		mg	Each			
Ianufacturing	Process Informa	ation		,													
Termina	Plating / Grid Array Material		Terminal Base Alloy J		J-STD-020 M	ISL Rating	Peak Pro	k Process Body Temperature Max Time		Time at Peal	ne at Peak Tempera		nture Number of Reflow Cycles		les		
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 3		3		260		С	30 seco		secon	ds 3				
Comments																	
TTENTION: MS	L 3 Rated item requir	es Bake and I	Ory Pack (after	r electrical test)													
or more informat	ion regarding materia	l composition	please refer to	page 3													

RoHS Material Composition Declaration			Declaration Type *	Detail	ed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a		
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimuly and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per t	he definition above except for defined Rol	IS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	29.61	mg	Supplier	Silicon (Si)	7440-21-3		29.61	mg
Die Attach	12.56	mg		Epoxy resin	proprietary data		1.256	mg
			Supplier	Silver (Ag)	7440-22-4		10.048	mg
			Supplier	Formaldehyde Polymer	9003-36-5		1.256	mg
Lead Frame	196.75	mg	Supplier	Zinc (Zn)	7440-66-6		0.2361	mg
			Supplier	Iron (Fe)	7439-89-6		4.6236	mg
			Supplier	Copper (Cu)	7440-50-8		191.8313	mg
			Supplier	Phosphorus (P)	7723-14-0		0.059	mg
Mold Compound-Black	545.87	mg		Epoxy resin	proprietary data		40.9403	mg
			Supplier	Phenolic Resin	Proprietary Data		13.6468	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		40.9403	mg
			Supplier	Carbon Black (C)	1333-86-4		2.7293	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		447.6134	mg
Plating	6.53	mg	Supplier	Palladium (Pd)	7440-05-3		0.4571	mg
			В	Nickel (Ni)	7440-02-0		5.9423	mg
			Supplier	Gold (Au)	7440-57-5		0.1306	mg
Wire Bond - Au	0.69	mg	Supplier	Gold (Au)	7440-57-5		0.69	mg